



SAMSUNG ELECTRONICS AMERICA, INC.
American QA Lab
19 Chapin Rd. Building D
Pine Brook, NJ 07058

Date: JULY. 03, 2017

FCC ID: A3LSMJ701M

We attest that

DC-HSDPA : WCDMA B4 /B2 Subset 3/4 mostly higher than the tune up power with MPR
HSUPA : WCDMA B5 Subset 1 mostly lower than the tune up power with MPR

@ Developer's opinion.

It is expected by the manufacture that MPR for some HSPA subtests may be up to 2dB more than specified by 3GPP, but also as low as 0 dB according to the chipset implementation in this model

"This each case's powers are satisfy 3GPP power spec. some subset power didn't meet MPR in lab test, but we want to progress with measured value."

Sincerely,

A handwritten signature in black ink, appearing to be "Chanho, Youn".

CHANHO, YOUN

General Manager

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